	1	2 3		4		5	6
$\bigcirc$	PRODUCT NUMBER SEE TABLE						
<u>A</u>	850 [2 REF	1.59]093 [2.35] 2X 1230 [31.24] REF.		●.040 ●.040 ●.020 020 0.51] ●.040 ●.040 ●.040 ●.020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 0.51] 020 020 0.51] 020 020 020 020 020 020 020 02	<ul> <li> </li> <li> </li> <li> </li> <li> </li> <li> </li> <li> </li> </ul>		A
B							В
	.025 [0.63] REF.						<u> </u>
d Copyright FCI				tr     ecn     nodr     date     toleran       K     EUX-W-000459     ZK     11/29/11     angles       E     M04-0230     MHT     12/8/04     0°±2°       F     M05-0052     ERE     3/19/05     dr     R.       G     M06-0285     AGS     7/28/06     engr       H     M06-0365     AGS     9/21/06     chr       J     M09-0048     MHT     3/12/09     appd       sheet     revisionK     K	Linea 2001:05:00:00:00:00:00:00:00:00:00:00:00:00:	title 1X8 VERTICAL HEADER ASSEMBLY dwg no sheet1of 98775 type Product Customer Dra	A3 awing D
	form A3	2	3	4 <b>PD</b> \$	S: Rev :K STATUS	SReleased Printed: Jan 0	

	- L						
98775->		LEAD FREE COL 1. 70343 L 2. 80166 0 3. 70634 D 4. 701 BLA0 5. 70511 - S 7. 70455 S 8. 80189 P 9. 70419 P	OPTION © ⑦ OR ④ T-GRAY — - FF WHITE K-GRAY — - CK LATE-GRAY — ILVER GRAY	OBS OBS OBS OBS		2. ( M G G G A F C A M F C C A A F C C A A F C C A A A A A A A	HEAI MAT JL- GRO MAT SIGN SIGN SIGN SIGN SIGN MAT SIGN SIGN SIGN SIGN SIGN SIGN SIGN SIGN
ormı A3	1		8		3		                 

213

1

А

В

С

FCI

Copyright

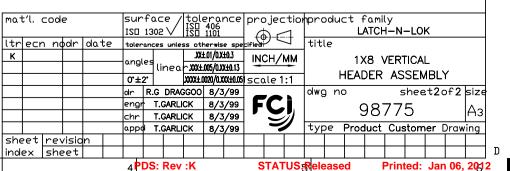
D

ເງົ

## S:

- ADER SHROUD AT'L: HIGH TEMPERATURE THERMOPLASTIC. -94V-0 RATED.
- ROUND CONTACT AT'L: COPPER ALLOY ATING: 100–160u"/2.54–4.06u TIN
- GNAL CONTACT AT'L: COPPER ALLOY ATING: PERFORMANCE PLATING WILL BE EITHER GOLD OR GXT CONTACT AREA OR TAIL, OPTIONALLY (78-295u") TIN ON TAIL.
- JMBERS SHOWN ARE FOR G.E. LEXAN AND RE FOR REFERENCE ONLY.
- IS ASSEMBLY U.L. APPROVED PER LE E66906 VOL. 1. SEC. 84 AND SA APPROVED PER MASTER FILE 846923
- D LF SUFFIX AT THE END OF PART NUMBER FOR LEAD FREE OPTION.
- IE HOUSING WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMPERATURE OR 15 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.5mm NIMUM THICK CIRCUIT BOARD. SEE APPLICATION NOTES/PROCEDURES THEY ARE AVAILABLE.
- IS PRODUCT MEETS EUROPEAN UNION DIRECTIVES AND OTHER UNTRY REGULATION AS DESCRIBED IN GS-22-008.
- RODUCT SPEC: GS-12-003

К



51

С

6

Α

В

## **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

FCI / Amphenol: 98775-104LF